

# NCV8718

## Voltage Regulator - Low Dropout, Low Iq, Wide Input

### 300 mA

The NCV8718 is 300 mA LDO Linear Voltage Regulator. It is a very stable and accurate device with ultra-low quiescent current consumption (typ. 4  $\mu$ A over the full temperature range) and a wide input voltage range (up to 24 V). The regulator incorporates several protection features such as Thermal Shutdown and Current Limiting.

#### Features

- Operating Input Voltage Range: 2.5 V to 24 V
- Fixed Voltage Options Available: 1.2 V to 5 V (upon request)
- Adjustable Voltage Option from 1.2 V to 5 V
- Ultra-Low Quiescent Current: typ. 4  $\mu$ A over Temperature
- $\pm 2\%$  Accuracy Over Full Load, Line and Temperature Variations
- PSRR: 60 dB at 1 kHz
- Noise: typ. 36  $\mu$ V<sub>RMS</sub> from 100 Hz to 100 kHz
- Stable with Small 1  $\mu$ F Ceramic Capacitor
- Soft-start to Reduce Inrush Current and Overshoots
- Thermal Shutdown and Current Limit Protection
- SOA Limiting for High Vin / High Iout – Static / Dynamic
- Active Discharge Option Available (upon request)
- Available in WDFN6 2x2 mm Package
- NCV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable; Device Temperature Grade 1: -40°C to +125°C Ambient Operating Temperature Range
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

#### Typical Applications

- Wireless Chargers
- Portable Equipment
- Communication Systems
- In-Vehicle Networking
- Telematics, Infotainment and Clusters
- General Purpose Automotive

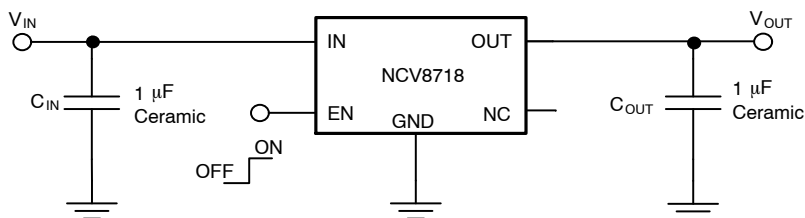


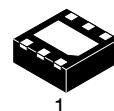
Figure 1. Typical Application Schematic



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#### MARKING DIAGRAMS

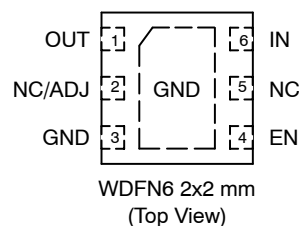


WDFN6  
MT SUFFIX  
CASE 511BR



XX = Specific Device Code  
M = Date Code

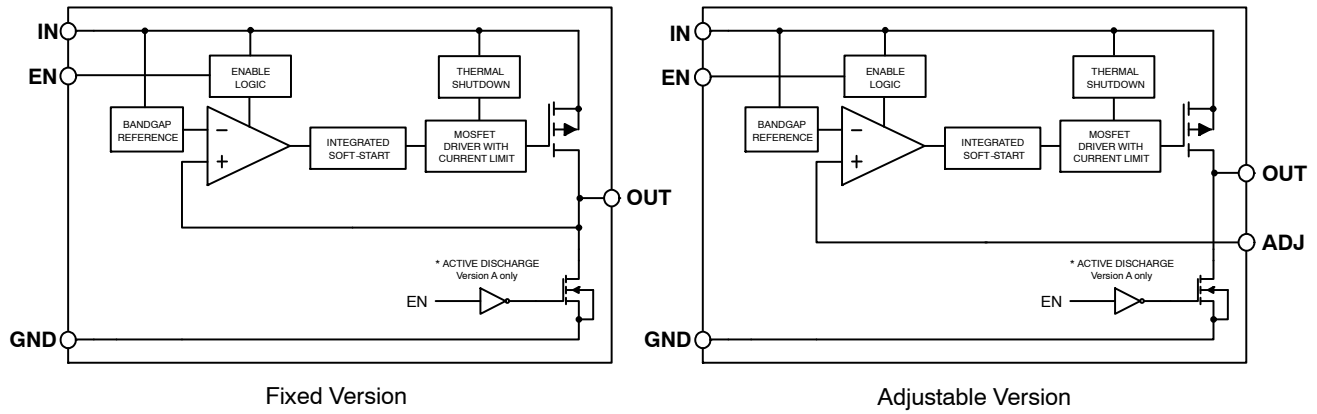
#### PIN CONNECTIONS



#### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 6 of this data sheet.

# NCV8718



**Figure 2. Simplified Block Diagram**

**Table 1. PIN FUNCTION DESCRIPTION**

Pin No. (WDFN6)	Pin Name	Description
6	IN	Input pin. A small capacitor is needed from this pin to ground to assure stability.
3, EXP	GND	Power supply ground.
4	EN	Enable pin. Driving this pin high turns on the regulator. Driving EN pin low puts the regulator into shut-down mode.
2	NC / ADJ	Fixed Version: No connection. This pin can be tied to ground to improve thermal dissipation or left disconnected. Adjustable Version: Feedback pin for set-up output voltage. Use resistor divider for voltage selection.
1	OUT	Regulated output voltage pin. A small 1 $\mu$ F ceramic capacitor is needed from this pin to ground to assure stability.
5	N/C	No connection. This pin can be tied to ground to improve thermal dissipation or left disconnected.

**Table 2. ABSOLUTE MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Input Voltage (Note 1)	$V_{IN}$	-0.3 to 24	V
Enable Voltage	$V_{EN}$	-0.3 to $V_{IN+0.3}$	V
Output Voltage	$V_{OUT}$	-0.3 to $V_{IN+0.3}$ (max. 6)	V
Output Short Circuit Duration	$t_{SC}$	Indefinite	s
Maximum Junction Temperature	$T_{J(MAX)}$	150	$^{\circ}C$
Storage Temperature	$T_{STG}$	-55 to 150	$^{\circ}C$
ESD Capability, Human Body Model (Note 2)	$ESD_{HBM}$	2000	V
ESD Capability, Charged Device Model (Note 2)	$ESD_{CDM}$	1000	V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Refer to ELECTRICAL CHARACTERISTICS and APPLICATION INFORMATION for Safe Operating Area.

2. This device series incorporates ESD protection and is tested by the following methods:

ESD Human Body Model tested per AEC-Q100-002 (EIA/JESD22-A114)

ESD Charged Device Model tested per EIA/JESD22-C101, Field Induced Charge Model.

Latch up Current Maximum Rating tested per JEDEC standard: JESD78. Latch-up is not guaranteed on ENABLE pin.

**Table 3. RECOMMENDED OPERATING RANGES**

Rating	Symbol	Min	Max	Unit
Input Voltage	$V_{IN}$	2.5	24	V
Junction Temperature	$T_J$	-40	+125	$^{\circ}C$

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

**Table 4. THERMAL CHARACTERISTICS**

Rating	Symbol	Value	Unit
Thermal Characteristics, WDFN6, 2 mm x 2 mm Thermal Resistance, Junction-to-Air	$R_{\theta JA}$	65	$^{\circ}\text{C/W}$

**Table 5. ELECTRICAL CHARACTERISTICS**  $-40^{\circ}\text{C} \leq T_J \leq 125^{\circ}\text{C}$ ;  $V_{IN} = 2.5\text{ V}$  or  $(V_{OUT} + 1.0\text{ V})$ , whatever is greater;  $I_{OUT} = 1\text{ mA}$ ,  $C_{IN} = C_{OUT} = 1\text{ }\mu\text{F}$ , unless otherwise noted. Typical values are at  $T_J = +25^{\circ}\text{C}$ . (Note 3)

Parameter	Test Conditions		Symbol	Min	Typ	Max	Unit
Operating Input Voltage			V <sub>IN</sub>	2.5		24	V
Output Voltage Accuracy (fixed versions)	−40°C ≤ T <sub>J</sub> ≤ 125°C, V <sub>OUT</sub> + 1 V < V <sub>IN</sub> < 16 V, 0.1 mA < I <sub>OUT</sub> < 300 mA (Note 5)	V <sub>OUT</sub> < 1.8 V	V <sub>OUT</sub>	−3%		+3%	V
		V <sub>OUT</sub> ≥ 1.8 V		−2%		+2%	
Reference Voltage	−40°C ≤ T <sub>J</sub> ≤ 125°C, V <sub>OUT</sub> + 1 V < V <sub>IN</sub> < 16 V		V <sub>ADJ</sub>		1.2		V
Reference Voltage Accuracy	−40°C ≤ T <sub>J</sub> ≤ 125°C, V <sub>OUT</sub> + 1 V < V <sub>IN</sub> < 16 V		V <sub>OUT</sub>	−2%		+2%	V
Line Regulation	V <sub>OUT</sub> + 1 V ≤ V <sub>IN</sub> ≤ 16 V, I <sub>out</sub> = 1 mA		Reg <sub>LINE</sub>		10		mV
Load Regulation	I <sub>OUT</sub> = 0.1 mA to 300 mA		Reg <sub>LOAD</sub>		10		mV
Dropout Voltage	V <sub>DO</sub> = V <sub>IN</sub> − (V <sub>OUT(NOM)</sub> − 3%), I <sub>OUT</sub> = 300 mA (Note 4)	2.1 V − 2.4 V	V <sub>DO</sub>		490		mV
		2.5 V − 2.7 V			335	505	
		2.8 V − 3.2 V			305	475	
		3.3 V − 4.9 V			285	450	
		5 V			260	395	
Maximum Output Current	V <sub>IN</sub> = V <sub>OUT</sub> + 1 V (Note 5)		I <sub>LIM</sub>	300		800	mA
Disable Current	V <sub>EN</sub> = 0 V, V <sub>IN</sub> = 5 V		I <sub>DIS</sub>		0.1	1.0	μA
Quiescent Current	I <sub>OUT</sub> = 0 mA, −40°C ≤ T <sub>J</sub> ≤ 125°C		I <sub>Q</sub>		4.0	8.0	μA
Ground Current	I <sub>OUT</sub> = 1 mA		I <sub>GND</sub>		7.0		μA
	I <sub>OUT</sub> = 10 mA				50		
	I <sub>OUT</sub> = 300 mA				300		
Power Supply Rejection Ratio	V <sub>IN</sub> = 3.5 V + 100 mV <sub>pp</sub> V <sub>OUT</sub> = 2.5 V I <sub>OUT</sub> = 1 mA, C <sub>out</sub> = 1 μF	f = 100 Hz f = 1 kHz f = 10 kHz f = 100 kHz	PSRR		70 60 41 35		dB
Output Noise Voltage	V <sub>OUT</sub> = 1.2 V, I <sub>OUT</sub> = 10 mA f = 100 Hz to 100 kHz		V <sub>N</sub>		36		μV <sub>rms</sub>
Enable Input Threshold Voltage	Voltage increasing		V <sub>EN_HI</sub>	1.2	–	–	V
	Voltage decreasing		V <sub>EN_LO</sub>	–	–	0.4	
ADJ Pin Current	V <sub>IN</sub> = V <sub>OUT</sub> + 1 V		I <sub>ADJ</sub>		0.1	1.0	μA
EN Pin Current	V <sub>EN</sub> = 5.5 V		I <sub>EN</sub>		100		nA
Active Output Discharge Resistance	V <sub>IN</sub> = 5.5 V, V <sub>EN</sub> = 0 V		R <sub>dis</sub>		100		Ω
Thermal Shutdown Temperature (Note 6)	Temperature increasing from T <sub>J</sub> = +25°C		T <sub>SD</sub>		165		°C
Thermal Shutdown Hysteresis (Note 6)	Temperature falling from T <sub>SD</sub>		T <sub>SDH</sub>	–	25	–	°C

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

- Performance guaranteed over the indicated operating temperature range by design and/or characterization production tested at  $T_J = T_A = 25^{\circ}\text{C}$ . Low duty cycle pulse techniques are used during testing to maintain the junction temperature as close to ambient as possible.
- Voltage dropout for voltage variants below 2.1 V is given by minimum input voltage 2.5 V.
- Respect SOA
- Guaranteed by design and characterization.

TYPICAL CHARACTERISTICS

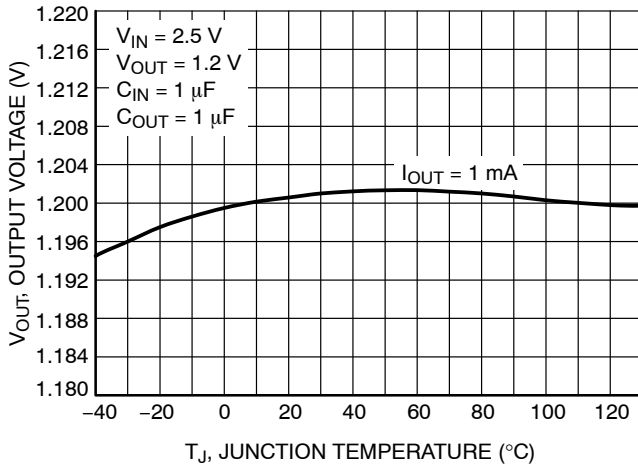


Figure 3. Output Voltage vs. Temperature –  $V_{OUT} = 1.2\text{ V}$

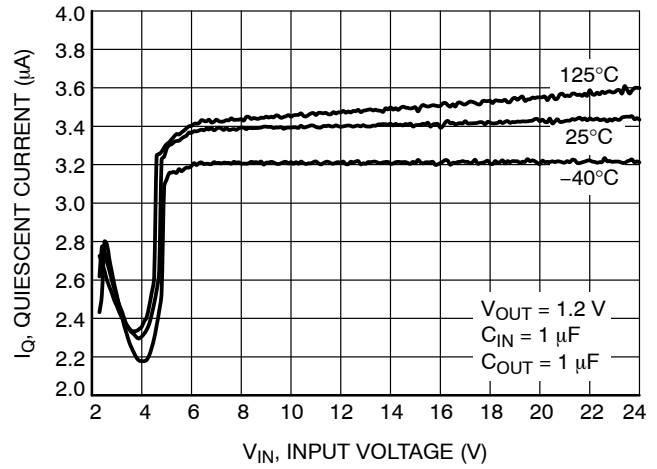


Figure 4. Quiescent Current vs. Input Voltage

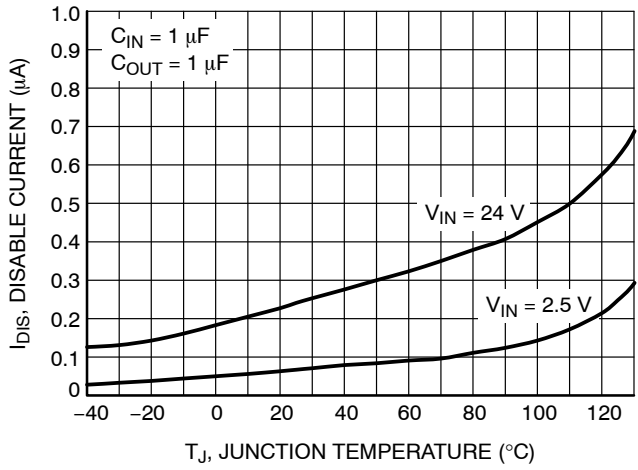


Figure 5. Disable Current vs. Temperature

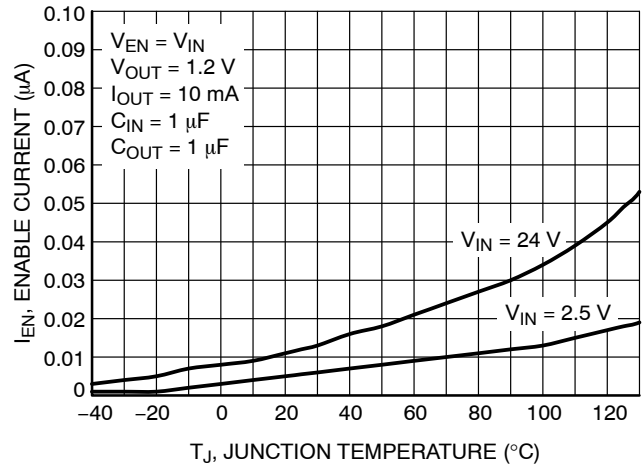


Figure 6. Current to Enable Pin vs. Temperature

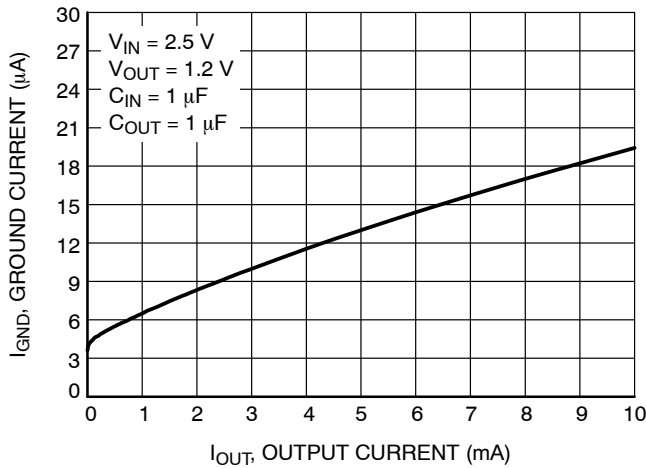


Figure 7. Ground Current vs. Output Current –  $V_{OUT} = 1.2\text{ V}$

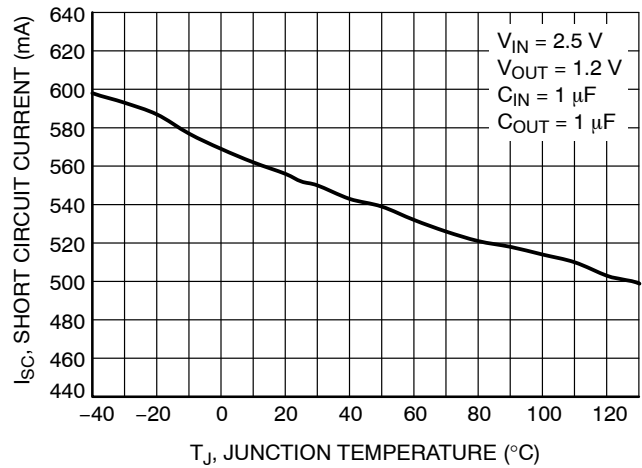
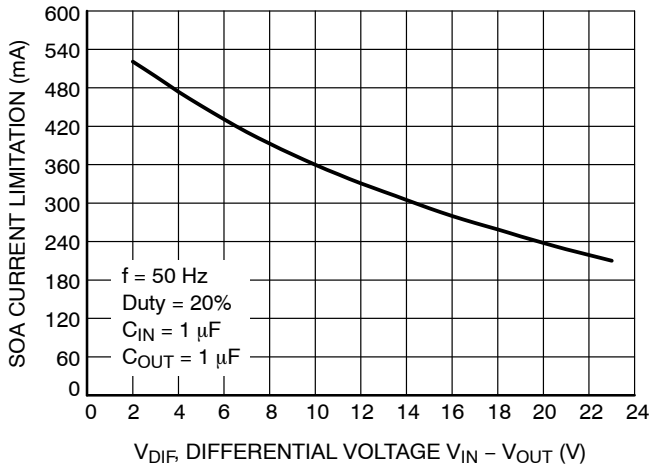
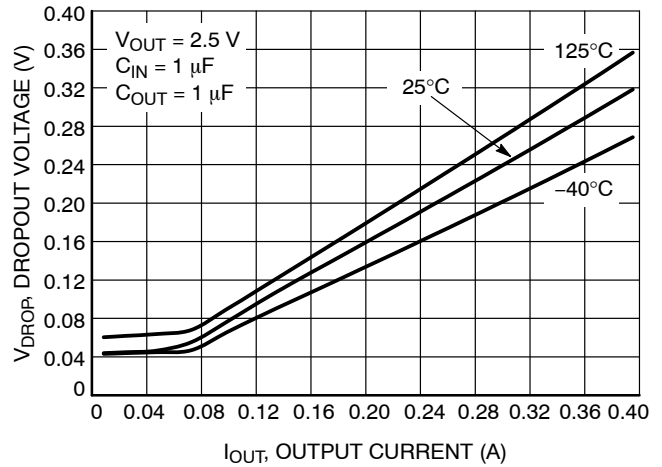


Figure 8. Short Circuit Current vs. Temperature

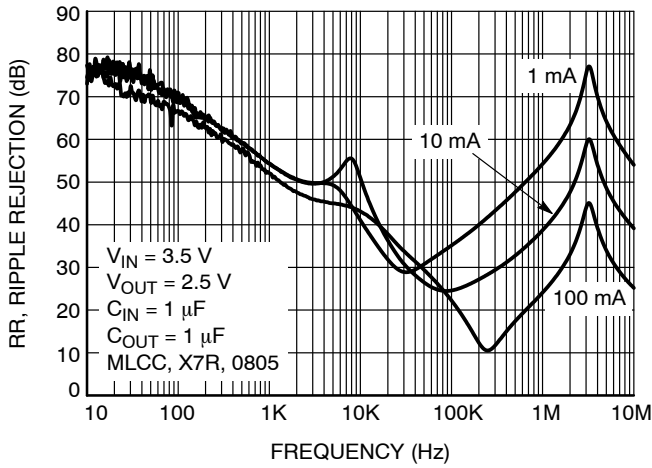
TYPICAL CHARACTERISTICS



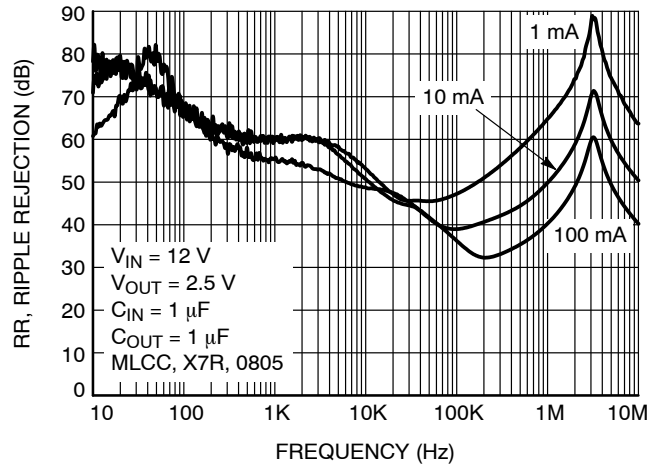
**Figure 9. SOA Current Limit vs. Differential Voltage**



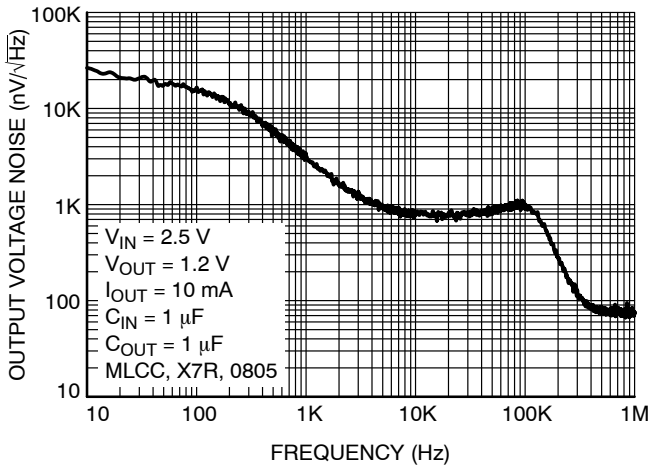
**Figure 10. Dropout Voltage vs. Output Current –  $V_{OUT} = 2.5\text{ V}$**



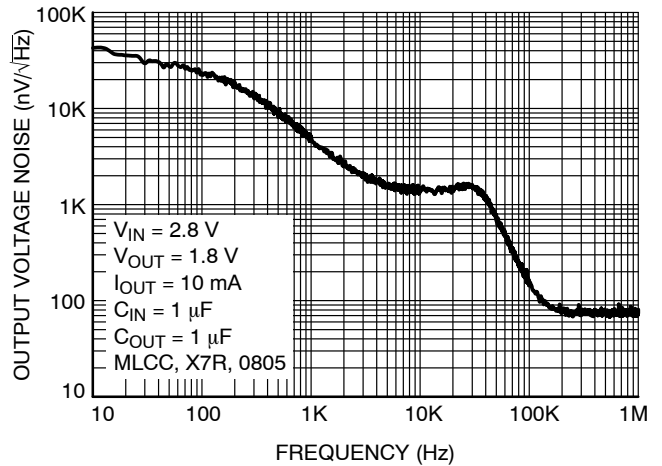
**Figure 11. Power Supply Rejection Ratio vs. Current,  $V_{IN} = 3.5\text{ V}$ ,  $C_{OUT} = 1\text{ μF}$**



**Figure 12. Power Supply Rejection Ratio vs. Current,  $V_{IN} = 12\text{ V}$ ,  $C_{OUT} = 1\text{ μF}$**



**Figure 13. Output Voltage Noise Spectral Density for  $V_{OUT} = 1.2\text{ V}$ ,  $I_{OUT} = 10\text{ mA}$ ,  $C_{OUT} = 1\text{ μF}$**



**Figure 14. Output Voltage Noise Spectral Density for  $V_{OUT} = 1.8\text{ V}$ ,  $I_{OUT} = 10\text{ mA}$ ,  $C_{OUT} = 1\text{ μF}$**

## APPLICATIONS INFORMATION

The NCV8718 is the member of new family of Wide Input Voltage Range Low Dropout Regulators which delivers Ultra Low Ground Current consumption, Good Noise and Power Supply Rejection Ratio Performance. The NCV8718 incorporates EN pin and soft-start feature for simple controlling by microprocessor or logic.

### Input Decoupling (C<sub>IN</sub>)

It is recommended to connect at least 1 µF ceramic X5R or X7R capacitor between IN and GND pin of the device. This capacitor will provide a low impedance path for any unwanted AC signals or noise superimposed onto constant input voltage. The good input capacitor will limit the influence of input trace inductances and source resistance during sudden load current changes.

Higher capacitance and lower ESR capacitors will improve the overall line transient response.

### Output Decoupling (C<sub>OUT</sub>)

The NCV8718 does not require a minimum Equivalent Series Resistance (ESR) for the output capacitor. The device is designed to be stable with standard ceramics capacitors with values of 1 µF or greater. The X5R and X7R types have the lowest capacitance variations over temperature thus they are recommended.

### Power Dissipation and Heat Sinking

The maximum power dissipation supported by the device is dependent upon board design and layout. Mounting pad configuration on the PCB, the board material, and the ambient temperature affect the rate of junction temperature rise for the part. For reliable operation junction temperature should be limited to +125°C.

The maximum power dissipation the NCV8718 can handle is given by:

$$P_{D(MAX)} = \frac{[T_{J(MAX)} - T_A]}{R_{\theta JA}} \quad (\text{eq. 1})$$

The power dissipated by the NCV8718 for given application conditions can be calculated from the following equations:

$$P_D \approx V_{IN}(I_{GND} + I_{OUT}) + I_{OUT}(V_{IN} - V_{OUT}) \quad (\text{eq. 2})$$

or

$$V_{IN(MAX)} \approx \frac{P_{D(MAX)} + (V_{OUT} \times I_{OUT})}{I_{OUT} + I_{GND}} \quad (\text{eq. 3})$$

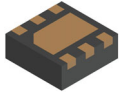
### Hints

V<sub>IN</sub> and GND printed circuit board traces should be as wide as possible. When the impedance of these traces is high, there is a chance to pick up noise or cause the regulator to malfunction. Place external components, especially the output capacitor, as close as possible to the NCV8718, and make traces as short as possible.

## ORDERING INFORMATION

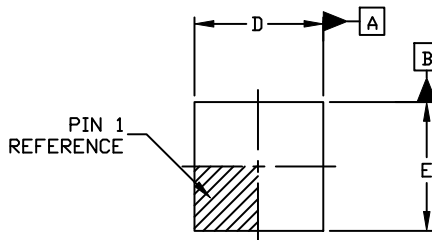
Device Part No.	Voltage Option	Marking	Option	Package	Shipping <sup>†</sup>
NCV8718AMTADJTBG	Adj.	GA	With Active Output Discharge	WDFN6 (Pb-Free)	3000 / Tape & Reel
NCV8718AMT180TBG	1.8 V	GP			
NCV8718AMT300TBG	3.0 V	GQ			
NCV8718AMT330TBG	3.3 V	GR			
NCV8718AMT500TBG	5.0 V	GM			
NCV8718BMTADJTBG	Adj.	GC	Without Active Output Discharge		
NCV8718BMT180TBG	1.8 V	GU			
NCV8718BMT300TBG	3.0 V	GV			
NCV8718BMT330TBG	3.3 V	GW			
NCV8718BMT500TBG	5.0 V	GE			

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

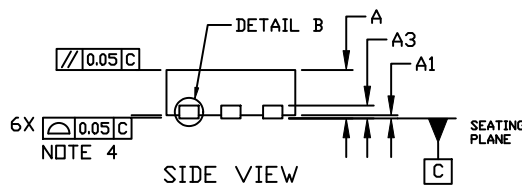


**WDFN6 2x2, 0.65P**  
**CASE 511BR**  
**ISSUE C**

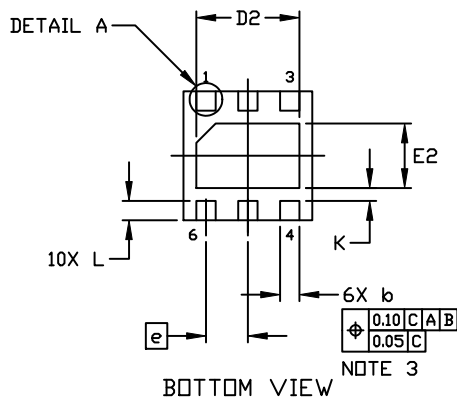
DATE 01 DEC 2021



TOP VIEW



SIDE VIEW



BOTTOM VIEW

**GENERIC**  
**MARKING DIAGRAM\***

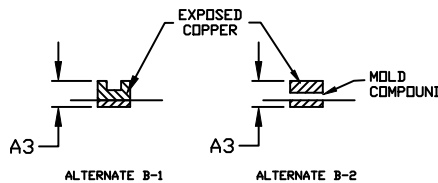


XX = Specific Device Code  
M = Date Code

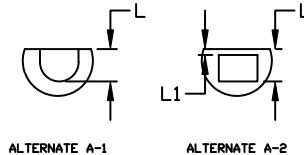
\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

**NOTES:**

1. DIMENSION AND TOLERANCING PER ASME Y14.5, 2009.
2. CONTROLLING DIMENSION: MILLIMETERS
3. DIMENSION *b* APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 MM FROM THE TERMINAL TIP.
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

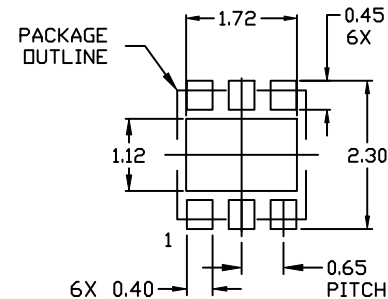


DETAIL B  
ALTERNATE CONSTRUCTION



DETAIL A  
ALTERNATE CONSTRUCTIONS

DIM	MILLIMETERS		
	MIN.	NOM.	MAX.
A	0.70	0.75	0.80
A1	0.00	---	0.05
A3	0.20 REF		
b	0.25	0.30	0.35
D	1.90	2.00	2.10
D2	1.50	1.60	1.70
E	1.90	2.00	2.10
E2	0.90	1.00	1.10
e	0.65 BSC		
K	0.20 REF		
L	0.20	0.30	0.40
L1	---	---	0.15



RECOMMENDED  
MOUNTING FOOTPRINT

For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERM/D.

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<b>DESCRIPTION:</b>	<b>WDFN6 2X2, 0.65P</b>	<b>PAGE 1 OF 1</b>

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